

# N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
100	0.0185 at V <sub>GS</sub> = 10 V	45	38 nC		

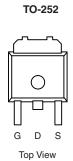
#### **FEATURES**

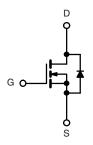
- TrenchFET® Power MOSFET
- 100 %  $R_q$  and UIS Tested





- Primary Side Switch
- Isolated DC/DC Converter





N-Channel	MOS	SFFT

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	100	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		45 <sup>a</sup>		
Continuous Drain Current /T = 150 °C	T <sub>C</sub> = 100 °C		30		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.2 <sup>b</sup>		
	T <sub>A</sub> = 100 °C		6.8 <sup>b</sup>		
Pulsed Drain Current		I <sub>DM</sub>	140	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	45 <sup>a</sup>		
Continuous Source-Diam blode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2 <sup>b</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	35		
Avalanche Energy	L = U.T IIII	E <sub>AS</sub>	101	mJ	
	T <sub>C</sub> = 25 °C		136.4	w	
Maximum Daylar Dissipation	T <sub>C</sub> = 100 °C	D	68.2		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>b</sup>		
	T <sub>A</sub> = 100 °C		1.5 <sup>b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	40	50	°C/W
Maximum Junction-to-Case	Sleady State	R <sub>thJC</sub>	0.85	1.1	C/VV

#### Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		110		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l <sub>D</sub> = 250 μA		- 12.5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$			5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0185		Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		33		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			2400		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		230		
Reverse Transfer Capacitance	C <sub>rss</sub>			80		
Total Gate Charge	$Q_g$			38	70	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		14		
Gate-Drain Charge	Q <sub>gd</sub>			12		
Gate Resistance	$R_g$	f = 1 MHz		1.6	2.5	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			12	20	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 1 \Omega$ $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		10	20	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			18	35	
Fall Time	t <sub>f</sub>			8	15	
Drain-Source Body Diode Characteris	stics					
Continuous Source-Drain Diode	I <sub>S</sub>	T <sub>C</sub> = 25 °C			35	^
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	-			100	A
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 15 A		0.85	1.5	V
Body Diode Reverse Recovery Time t <sub>rr</sub>				80	120	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T		160	240	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		57		ns
Reverse Recovery Rise Time	t <sub>b</sub>			23		

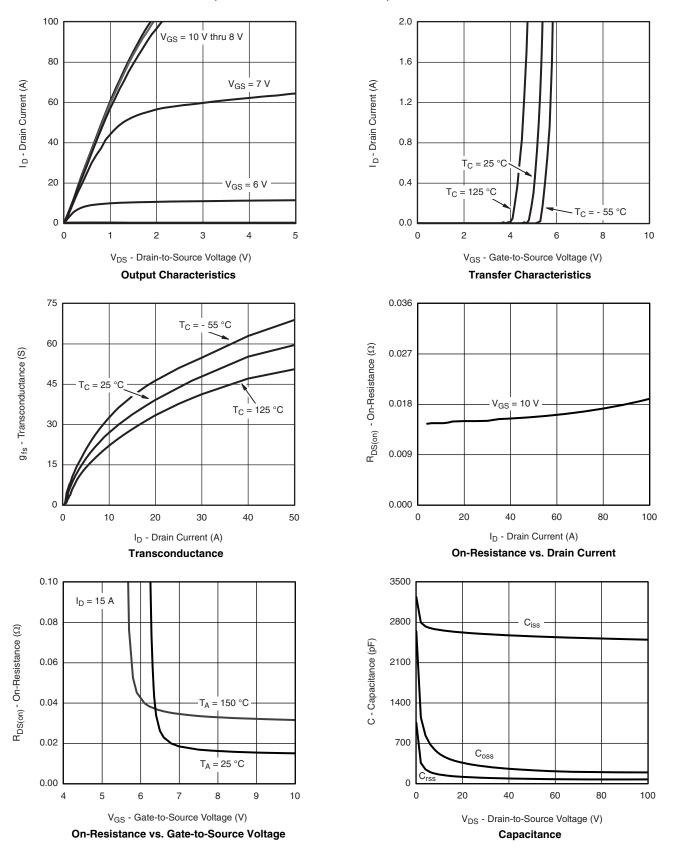
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)



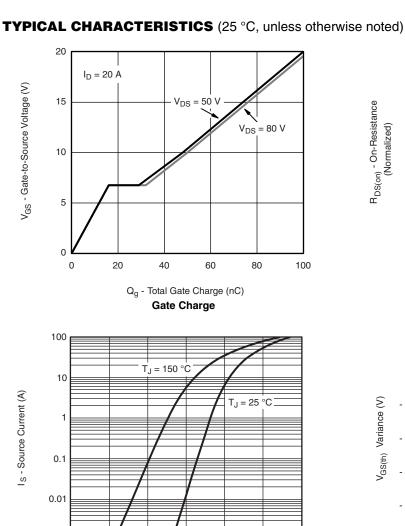
0.001

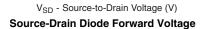
0.0

0.2

0.4





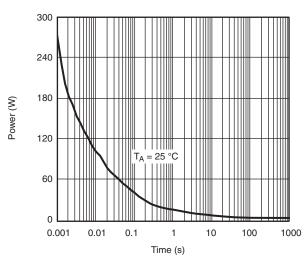


0.6

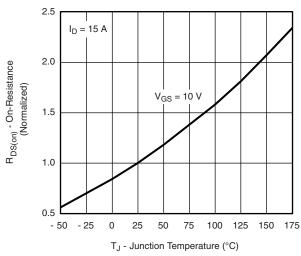
0.8

1.0

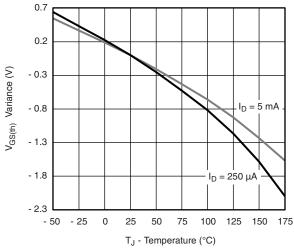
1.2



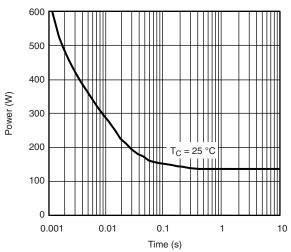
Single Pulse Power, Junction-to-Ambient



#### On-Resistance vs. Junction Temperature



Threshold Voltage



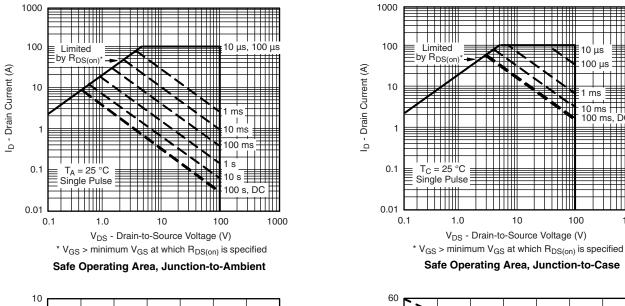
Single Pulse Power, Junction-to-Case

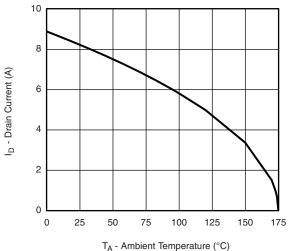


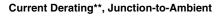
100 us

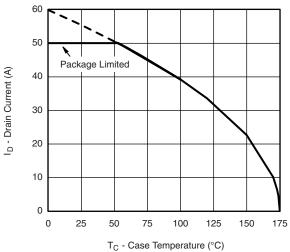
10 ms 100 ms,

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







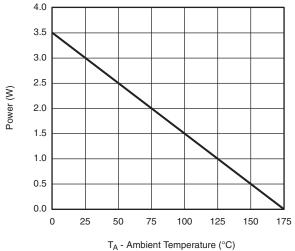


Current Derating\*\*, Junction-to-Case

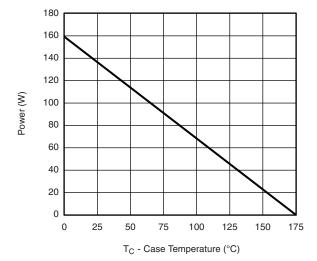
<sup>\*\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





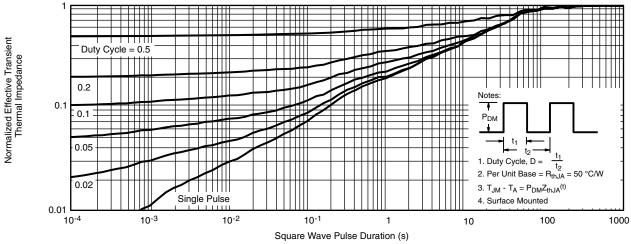


Power Derating\*\*, Junction-to-Case

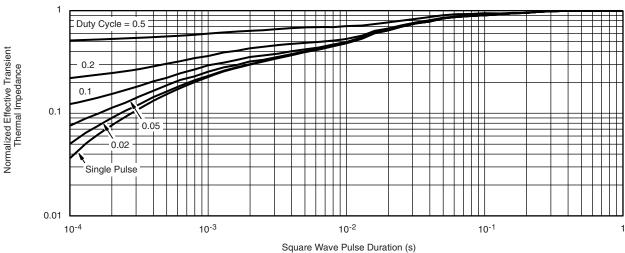
<sup>\*\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
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